



Spec No. :DS20-2022-0063 Effective Date: 06/10/2022

Revision: -

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4



Through Hole Lamp LTL1DEGYHJH155

Through Hole Lamp

LTL1DEGYHJH155

Rev	<u>Description</u>	<u>By</u>	<u>Date</u>			
P01	Preliminary New Specification (RDR-20220372)	Tina JH Chen	4/15/2022			
P02	Updated IV Spec.	Tina JH Chen	4/28/2022			
	Above data for PD and Customer tracking only					
-	New Specification, Upload in OPB2 system	Chalerm Ya.	06/07/2022			



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1. Description

CBI (Circuit Board Indicator) is a black plastic right angle Holder (Housing) which mates with Lite-On LED lamps. Lite-On CBI is available in a wide variety of packages, including top-view (Spacer) or right angle and horizontal or vertical arrays which is stackable and easy to assembly.

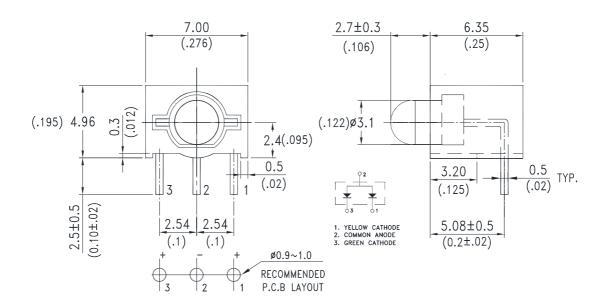
1.1. Features

- Designed for ease in circuit board assembly.
- Black case enhance contrast ratio.
- Halogen free product (Cl<900 ppm, Br<900 ppm, and Cl +Br<1500 ppm).
- Low power consumption.
- Lead free product & RoHS Compliant.
- T-1 lamp: Source bi-colors are AllnGaP green/AllnGaP yellow with white diffused lens.

1.2. Applications

- Communication.
- Computer.
- Consumer.
- Industrial.

2. Outline Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (.010") unless otherwise noted.
- 3. The Holder (Housing) material is plastic black.
- 4. LED lamp is green/yellow with white diffused lens.
- 5. Specifications are subject to change without notice.

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3. Absolute Maximum Ratings at TA=25℃

Parameter	Green	Yellow	Unit		
Power Dissipation	78	78	mW		
Peak Forward Current					
(Duty Cycle≦1/10, Pulse Width≦10µs)	120	120	mA		
DC Forward Current	30	30	mA		
Operating Temperature Range	-	-40℃ to + 85℃			
Storage Temperature Range	-40℃ to + 100℃				
Lead Soldering Temperature					
[2.0mm (.079") From Body]	260℃ for 5 Seconds Max.				

4. Electrical / Optical Characteristics at TA=25℃

Parameter	Symbol	Color	Min.	Тур.	Max.	Unit	Test Condition
Radiant Intensity	lv	Green	50	85	140		IF = 20mA
Radiant Intensity	IV	Yellow	140	240	400	mcd	Note 1,4
Viewie e Angele	004/0	Green		00		-l:	Note 2 (Fig.6)
Viewing Angle	201/2	Yellow		80		deg	
		Green		574			Measurement
Peak Emission Wavelength	λР	Yellow		590		nm	@Peak (Fig.1)
Danie aut Wasselau ath	\ -1	Green	564	570	574	nm	IF = 20mA ,Note 3
Dominant Wavelength	λd	Yellow	584	590	594		
Creative Line Light Width	^ \	Green		15			
Spectral Line Half-Width	Δλ	Yellow		20		nm	
Forward Voltage	VF	Green	1.6	2.0	2.5	V	IF = 20mA
Forward Vollage		Yellow	1.6	2.0	2.5		IF = ZUITIA
Reverse Current	IR	Green			10	μΑ	VR = 5V
IVeverse Onliell		Yellow			10		Note 6

NOTE:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2. θ1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, \(\lambda \) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Iv guarantee must be included with ±30% testing tolerance.
- 5. Reverse current is controlled by dice source.
- 6. Reverse voltage (VR) condition is applied for IR test only. The device is not designed for reverse operation.

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5. Typical Electrical / Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

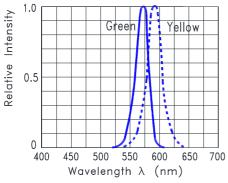
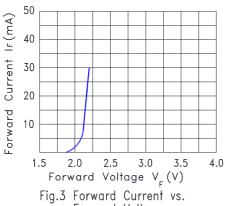


Fig.1 Relative Intensity VS. Wavelength



Forward Voltage

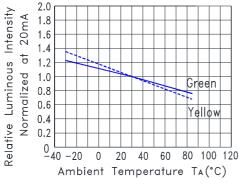


Fig.5 Relative Luminous Intensity VS. Ambient Temperature

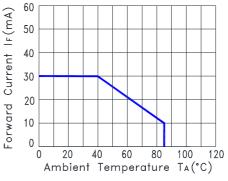


Fig.2 Forward Current Derating Curve

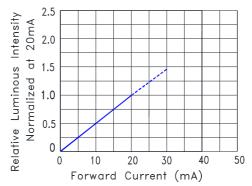


Fig.4 Relative Luminous Intensity vs. Forward Current

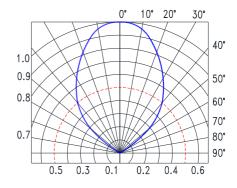


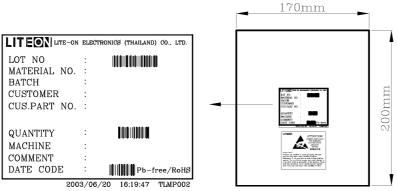
Fig.6 Spatial Distribution



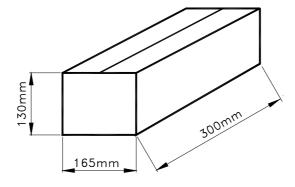
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6. Packing Specification

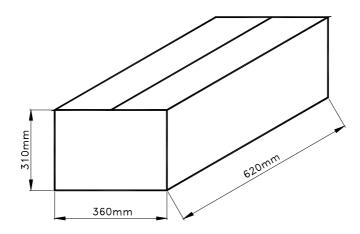
300, 200 or 100 pcs per packing bag



11 packing bags per Inner carton Total 3,300 pcs per Inner carton



8 inner cartons per outer carton
Total 26,400 pcs per outer carton
In every shipping lot, only the last pack will be non-full packing





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7. Bin Table Specification

Luminous Intensity			Unit : mcd @20mA		
Green			Yellow		
Bin Code	Min.	Max.	Bin Code	Min.	Max.
CD	50	85	GH	140	240
EF	85	140	JK	240	400

Note: Tolerance of each bin limit is ±30%

Dominant Wavelength (Green) Unit: nm @20mA			Dominant Wavelength (Yellow) Unit: nm @20mA		
Bin Code	Min	Max	Bin Code	Min	Max
H06	564	567	Y02	584	589
H07	567	570	Y03	589	594
H08	570	572			
H09	572	574			

Note: Tolerance of each bin limit is ±1nm



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8. CAUTIONS

8.1. Application

This LED lamp is good for application of indoor and outdoor sign, also ordinary electronic equipment.

8.2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

8.3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

8.4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming. Lead forming must be done before soldering, at normal temperature. During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

8.5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided. Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

	Soldering iron	Wave soldering		
Temperature Soldering time Position	350℃ Max. 3 seconds Max. (one time only) No closer than 2mm from the base of the epoxy bulb	Pre-heat Pre-heat time Solder wave Soldering time Dipping Position	120℃ Max. 60 seconds Max. 260℃ Max. 5 seconds Max. No lower than 2mm from the base of the epoxy bulb	

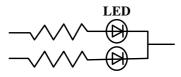
Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product. Max temperature of wave soldering is not means that Holder's HDT/Melting temperature.

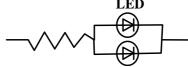
8.6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model (A)







- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

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8.7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

Suggested checking list:

Training and Certification

- 8.7.1.1. Everyone working in a static-safe area is ESD-certified?
- 8.7.1.2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 8.7.2.1. Static-safe workstation or work-areas have ESD signs?
- 8.7.2.2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 8.7.2.3. All ionizer activated, positioned towards the units?
- 8.7.2.4. Each work surface mats grounding is good?

Personnel Grounding

- 8.7.3.1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 8.7.3.1. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 8.7.3.2. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 8.7.3.3. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 8.7.3.4. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 8.7.4.1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 8.7.4.2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 8.7.4.3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 8.7.4.4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 8.7.5.1. Audit result reported to entity ESD control coordinator?
- 8.7.5.2. Corrective action from previous audits completed?
- 8.7.5.3. Are audit records complete and on file?

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9. Reliability Test

Classification	Test Item	Test Condition	Sample Size	Reference Standard
Endurance	Operation Life	Ta = Under room temperature IF = per datasheet maximum drive current Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
	High Temperature High Humidity storage	Ta = 60℃ RH = 90% Test Time= 240hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
Test	High Temperature Storage	Ta= 105 ± 5℃ Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low Temperature Storage	Ta= -55 ± 5℃ Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	JEITA ED-4701:200 202 (2001)
	Temperature Cycling	$100^\circ \text{C} \sim 25^\circ \text{C} \sim -40^\circ \text{C} \sim 25^\circ \text{C}$ 30mins 5mins 30mins 5mins 30 Cycles	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1051 (1995) MIL-STD-883G:1010 (2006) JEITA ED-4701:100 105 (2001) JESD22-A104C (2005)
	Thermal Shock	100 ± 5 °C ~ -30 °C ± 5 °C 15mins 15mins 30 Cycles (<20 secs transfer)	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1056 (1995) MIL-STD-883G:1011 (2006) MIL-STD-202G:107G (2002) JESD22-A106B (2004)
Environmental Test	Solder Resistance	T.sol = 260 ± 5℃ Dwell Time= 10±1 seconds 3mm from the base of the epoxy bulb	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2031(1995) JEITA ED-4701: 300 302 (2001)
	Solderability	T. sol = 245 ± 5 °C Dwell Time= 5 ± 0.5 seconds (Lead Free Solder, Coverage ≥ 95 % of the dipped surface)	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2026 (1995) MIL-STD-883G:2003 (2006) MIL-STD-202G:208H (2002) IPC/EIA J-STD-002 (2004)
	Soldering Iron	T. sol = 350 ± 5 °C Dwell Time= 3.5 ± 0.5 seconds	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-202G:208H (2002) JEITA ED-4701:300 302 (2001)

10. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

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